	CONNECTING INDUSTRIES® International and Par	osition Dec PC, Bannockb n-American co	c laration ourn, Illinois. A opyright conver	ll rights reserved nations.	under both	This docume level parts, t	ent is a declaration	tion of the encompas	substance ses all low	es within the er level ma	e manufactur tterials for w	rer listed it hich the m	em. Note: i anufacture	if the item is an as r has engineering	sembly with lowe responsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard			Form Type Distribute	Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, He				o, Homogei	Iomogeneous Materials and Mfg Information					
Supplier	Information														
Company n	name*	Company unique ID				Unique ID Authority					Response Date*				
onsemi												2024-05-21			
Contact Na	me		Title - Contact				Phone - Contact*				Email - Contact*				
Product-E	nv-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized	Representative*		Title - Representative				Phone - Representative*				Email - Representative*				
Product-E	nv-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date Version Manufacturing Site			· · · ·	Weight*	UOM	Unit Type		
		MUR110	00E				2024-05-21					2	250.99	mg	Each
Manufac	turing Proccess Informa	tion		•				·		•					
]	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temperatu		ure Max Time at Peak Tempe		Temperat	ure Numl	ber of Reflow Cyc	eles		
		CU Alloy			C 30			seconds 3							
Comments															
for more in	nformation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.18	mg	Supplier	Silicon (Si)	7440-21-3		0.18	mg
Die Attach Solder	7.98	mg	Supplier	Silver (Ag)	7440-22-4		0.1995	mg
			А	Lead (Pb)	7439-92-1	7a	7.3815	mg
			Supplier	Tin (Sn)	7440-31-5		0.399	mg
Lead Frame	125.08	mg	В	Nickel (Ni)	7440-02-0		0.2502	mg
			Supplier	Copper (Cu)	7440-50-8		124.8298	mg
Mold Compound-Black	116.8	mg		Epoxy resin	proprietary data		8.176	mg
			Supplier	Phenolic Resin	Proprietary Data		8.176	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		17.52	mg
			Supplier	Carbon Black (C)	1333-86-4		0.584	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		82.344	mg
Plating	0.95	mg	Supplier	Tin (Sn)	7440-31-5		0.95	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3